10-bit D-type flip-flop with 5 V tolerant inputs/outputs; positive-edge trigger; 3-state

Rev. 4 — 23 November 2012

**Product data sheet** 

## 1. General description

The 74LVC821A is a 10-bit D-type flip-flop featuring separate D-type inputs for each flip-flop and 3-state outputs for bus-oriented applications. A clock input (pin CP) and an output enable input (pin  $\overline{OE}$ ) are common to all flip-flops. The ten flip-flops store the state of their individual D-inputs that meet the set-up and hold times requirements on the LOW-to-HIGH CP transition. When pin  $\overline{OE}$  is LOW, the contents of the ten flip-flops are available at the outputs.

When pin  $\overline{OE}$  is HIGH, the outputs go to the high-impedance OFF-state. Operation of the  $\overline{OE}$  inputs does not affect the state of the flip-flops.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V and 5 V applications.

## 2. Features and benefits

- 5 V tolerant inputs and outputs; for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Flow-through pinout architecture
- 10-bit positive edge-triggered register
- Independent register and 3-state buffer operation
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-B exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C.

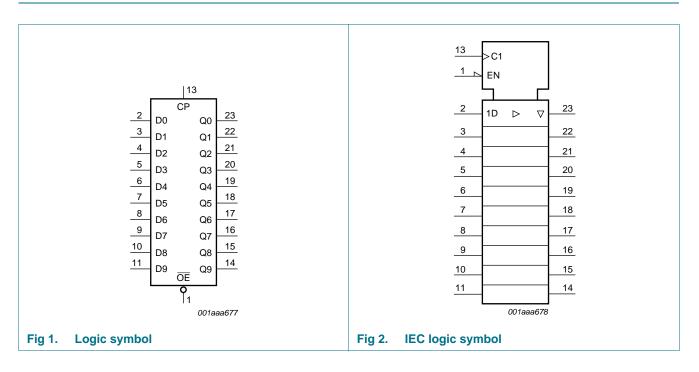


10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

## 3. Ordering information

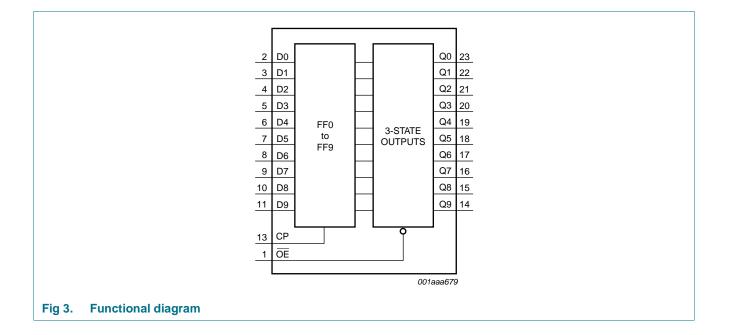
Type number	Package								
Type number	Раскаде		1	-					
	Temperature range	Name	Description	Version					
74LVC821AD	–40 °C to +125 °C	SO24	plastic small outline package; 24 leads; body width 7.5 mm	SOT137-1					
74LVC821ADB	–40 °C to +125 °C	SSOP24	plastic shrink small outline package; 24 leads; body width 5.3 mm	SOT340-1					
74LVC821APW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1					
74LVC821ABQ	–40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm	SOT815-1					

## 4. Functional diagram



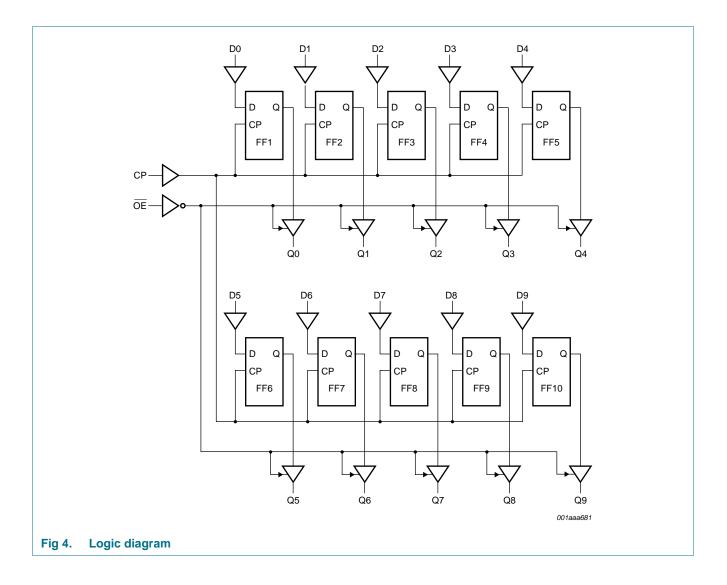
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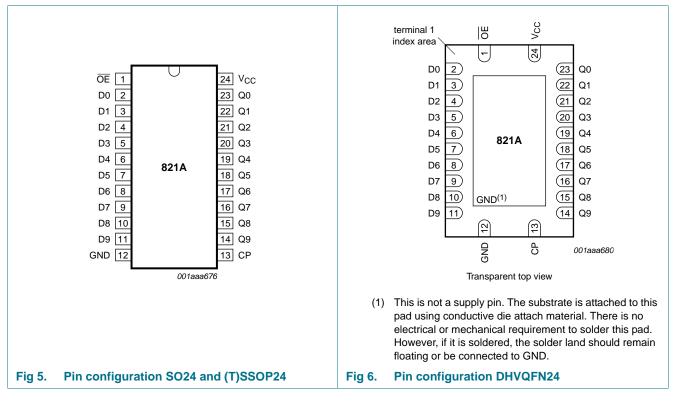
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10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

## 5. Pinning information

### 5.1 Pinning



### 5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
OE	1	output enable input (active LOW)
CP	13	clock input (LOW-to-HIGH, edge-triggered)
D[0:9]	2, 3, 4, 5, 6, 7, 8, 9, 10, 11	data input
Q[0:9]	23, 22, 21, 20, 19, 18, 17, 16, 7	15, 14 3-state flip-flop output
GND	12	ground (0 V)
V <sub>CC</sub>	24	supply voltage

10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

## 6. Functional description

#### Table 3.Function table

Operating mode	Input		Internal	Output	
	OE	СР	Dn	flip-flops	Qn
Load and read register	L	$\uparrow$	I	L	L
	L	$\uparrow$	h	Н	Н
Load register and disable outputs	Н	$\uparrow$	I	L	Z
	Н	$\uparrow$	h	Н	Z
Hold	L	H or L	Х	NC	NC

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time before the LOW-to-HIGH CP transition

L = LOW voltage level

I = LOW voltage level one set-up time before the LOW-to-HIGH CP transition

Z = high-impedance OFF-state

 $\uparrow$  = LOW-to-HIGH clock transition

X = don't care

NC = no change

## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_{O}$ > $V_{CC}$ or $V_{O}$ < 0 V	-	±50	mA
Vo	output voltage	HIGH or LOW state	[2] -0.5	V <sub>CC</sub> + 0.5	V
		3-state	<u>[2]</u> –0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	<u>[3]</u> _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO24 package: above 70 °C derate linearly with 8 mW/K.
 For SSOP24 and TSSOP24 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN24 package: above 60 °C derate linearly with 4.5 mW/K.

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## 8. Recommended operating conditions

Table 5.	Recommended operating of	conditions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC</sub> supply voltage			1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	HIGH or LOW state	0	-	V <sub>CC</sub>	V
		3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall	$V_{CC}$ = 1.65 V to 2.7 V	0	-	20	ns/V
	rate	$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	-40 °C to	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
V <sub>IH</sub>	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	$V_{CC}$ = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V <sub>IL</sub>	V <sub>IL</sub> LOW-level input voltage	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
		$V_{CC}$ = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35\times V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V	
V <sub>OH</sub>	V <sub>OH</sub> HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$						
		$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O}$ = 100 µA; V <sub>CC</sub> = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0$ = 8 mA; $V_{CC}$ = 2.3 V	-	-	0.6	-	0.8	V
		$I_0$ = 12 mA; $V_{CC}$ = 2.7 V	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	$V_{CC}$ = 3.6 V; $V_{I}$ = 5.5 V or GND	-	±0.1	±5	-	±20	μΑ

### 10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

Symbol	Parameter	Conditions	-40	–40 °C to +85 °C			–40 °C to +125 °C	
			Min	Typ <mark>[1]</mark>	Max	Min	Мах	
I <sub>OZ</sub>	OFF-state output current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL}; \ V_{CC} = 3.6 \ V; \\ V_{O} = 5.5 \ V \text{ or } GND; \end{array}$	-	0.1	±5	-	±20	μA
I <sub>OFF</sub>	power-off leakage current	$V_{CC}$ = 0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V	-	0.1	±10	-	±20	μΑ
I <sub>CC</sub>	supply current	$V_{CC}$ = 3.6 V; $V_{I}$ = $V_{CC}$ or GND; $I_{O}$ = 0 A	-	0.1	10	-	40	μΑ
Δl <sub>CC</sub>	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A$	-	5	500	-	5000	μΑ
Cl	input capacitance	$V_{CC} = 0 V$ to 3.6 V; V <sub>1</sub> = GND to V <sub>CC</sub>	-	5.0	-	-	-	pF

#### Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

## **10.** Dynamic characteristics

#### Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 10.

Symbol	Parameter	Conditions		T <sub>amb</sub> =	–40 °C to	+85 °C	–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub>	propagation	CP to Qn; see Figure 7	[2]						
	delay	$V_{CC} = 1.2 V$		-	18	-	-	-	ns
		$V_{CC}$ = 1.65 V to 1.95 V		2.4	8.6	17.1	2.3	19.7	ns
	$V_{CC}$ = 2.3 V to 2.7 V		1.8	4.5	8.8	1.6	10.1	ns	
	$V_{CC} = 2.7 V$		1.5	4.1	8.5	2.2	11.0	ns	
	$V_{CC}$ = 3.0 V to 3.6 V		1.5	3.8	7.3	2.0	9.5	ns	
t <sub>en</sub> enable tim	enable time	OE to Qn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	20	-	-	-	ns
		V <sub>CC</sub> = 1.65 V		1.8	7.7	17.4	1.6	20.1	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.5	4.3	9.6	1.3	11.0	ns
		$V_{CC} = 2.7 V$		1.3	4.4	8.8	2.4	11.0	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.5	3.5	7.6	1.5	9.5	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	9.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V		2.5	4.4	10.4	1.8	12.0	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.4	5.9	0.6	6.8	ns
		$V_{CC} = 2.7 V$		1.5	3.3	6.8	2.2	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.0	6.2	1.9	8.0	ns

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Symbol	Parameter	Conditions		T <sub>amb</sub> =	–40 °C to	+85 °C	–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>W</sub>	pulse width	clock HIGH or LOW; see Figure 7							
		$V_{CC}$ = 1.65 V to 1.95 V		5.0	-	-	5.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.7 V$		3.3	-	-	3.3	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		3.3	1.7	-	3.3	-	ns
t <sub>su</sub>	set-up time	Dn to CP; see Figure 8							
		$V_{CC}$ = 1.65 V to 1.95 V		3.5	-	-	3.5	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		0.9	-	-	0.9	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.9	0.6	-	1.9	-	ns
t <sub>h</sub>	hold time	Dn to CP; see Figure 8							
		$V_{CC}$ = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		$V_{CC}$ = 2.3 V to 2.7 V		2.0	-	-	2.0	-	ns
		$V_{CC} = 2.7 V$		1.5	-	-	1.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	0.0	-	1.5	-	ns
f <sub>max</sub>	maximum	see Figure 7							
	frequency	$V_{CC}$ = 1.65 V to 1.95 V		100	-	-	80	-	MHz
		$V_{CC}$ = 2.3 V to 2.7 V		125	-	-	100	-	MHz
		$V_{CC} = 2.7 V$		150	-	-	120	-	MHz
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		150	200	-	120	-	MHz
t <sub>sk(o)</sub>	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[3]</u>	-	-	1.0	-	1.5	ns
C <sub>PD</sub>	power	per input; $V_I = GND$ to $V_{CC}$	<u>[4]</u>						
	dissipation	$V_{CC}$ = 1.65 V to 1.95 V		-	12.5	-	-	-	pF
	capacitance	$V_{CC}$ = 2.3 V to 2.7 V		-	14.7	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	16.6	-	-	-	pF

#### Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 10</u>.

[1] Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

 $t_{\text{dis}}$  is the same as  $t_{\text{PLZ}}$  and  $t_{\text{PHZ}}.$ 

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$ 

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

 $C_L$  = output load capacitance in pF

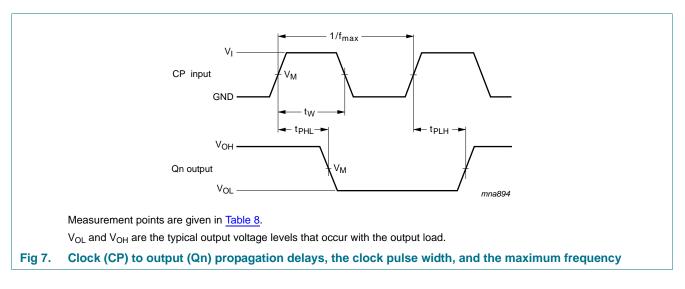
 $V_{CC}$  = supply voltage in Volts

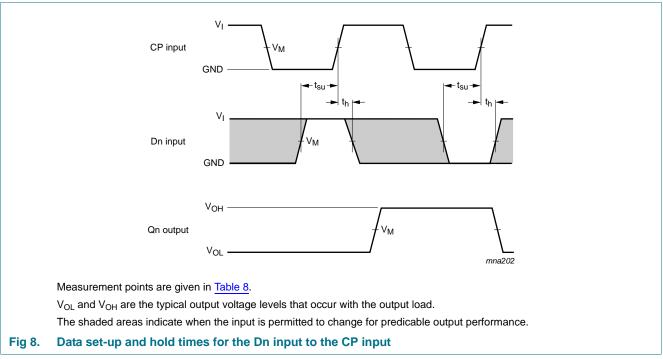
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$  = sum of the outputs

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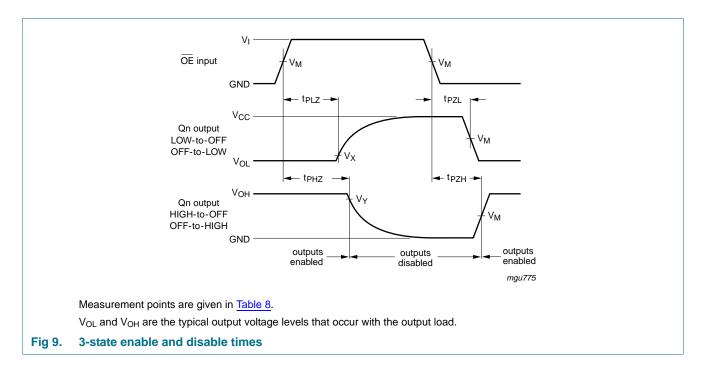
## 11. Waveforms





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#### Table 8. Measurement points

Supply voltage	Input		Output	Output				
V <sub>CC</sub>	VI	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
1.2 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
1.65 V to 1.95 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
2.3 V to 2.7 V	V <sub>CC</sub>	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V <sub>OL</sub> + 0.3 V	V <sub>OH</sub> – 0.3 V			

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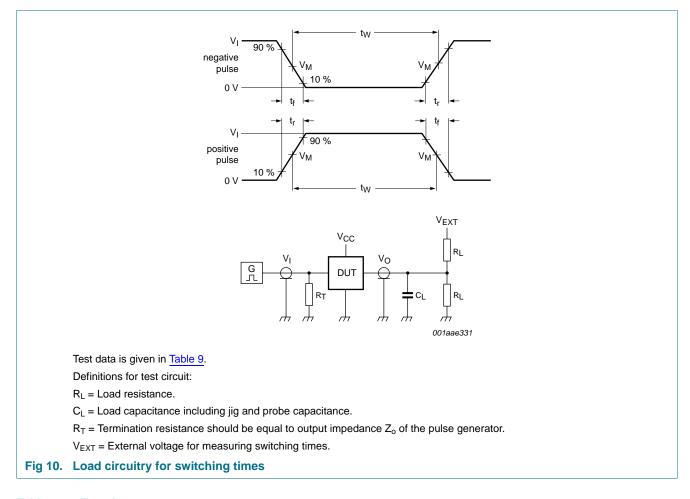


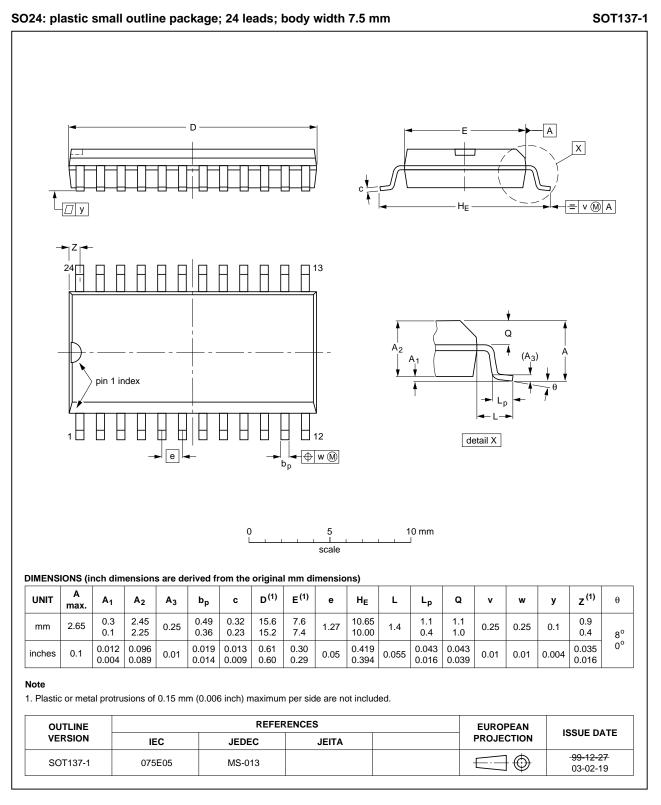
Table 9. Test data	a								
Supply voltage	Input		Load		V <sub>EXT</sub>	V <sub>EXT</sub>			
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PLZ</sub> , t <sub>PZL</sub>	t <sub>PHZ</sub> , t <sub>PZH</sub>		
1.2 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND		
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND		
2.3 V to 2.7 V	V <sub>CC</sub>	$\leq$ 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND		
2.7 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND		
3.0 V to 3.6 V	2.7 V	$\leq$ 2.5 ns	50 pF	500 Ω	open	$2 \times V_{CC}$	GND		

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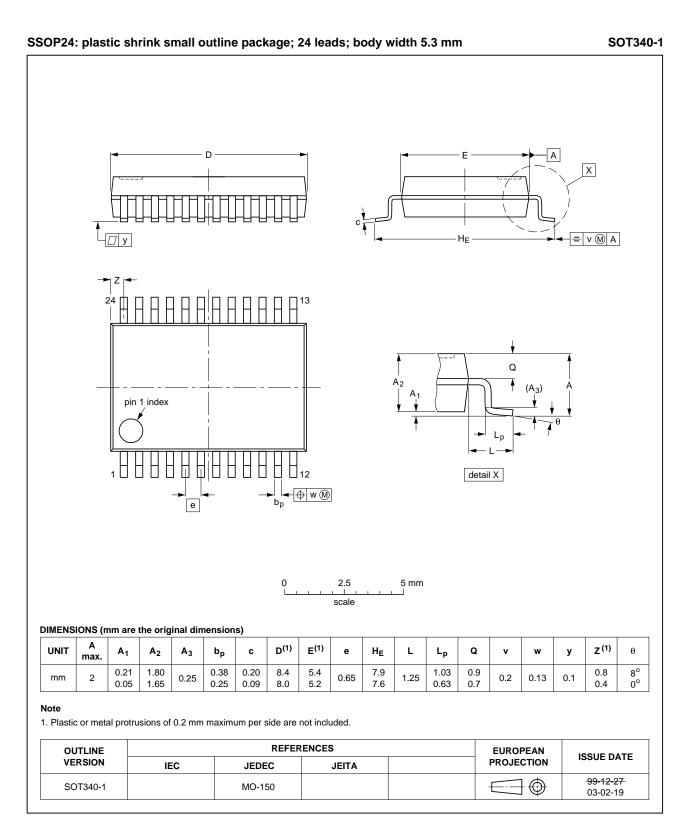
## 12. Package outline



### Fig 11. Package outline SOT 137-1 (SO24)

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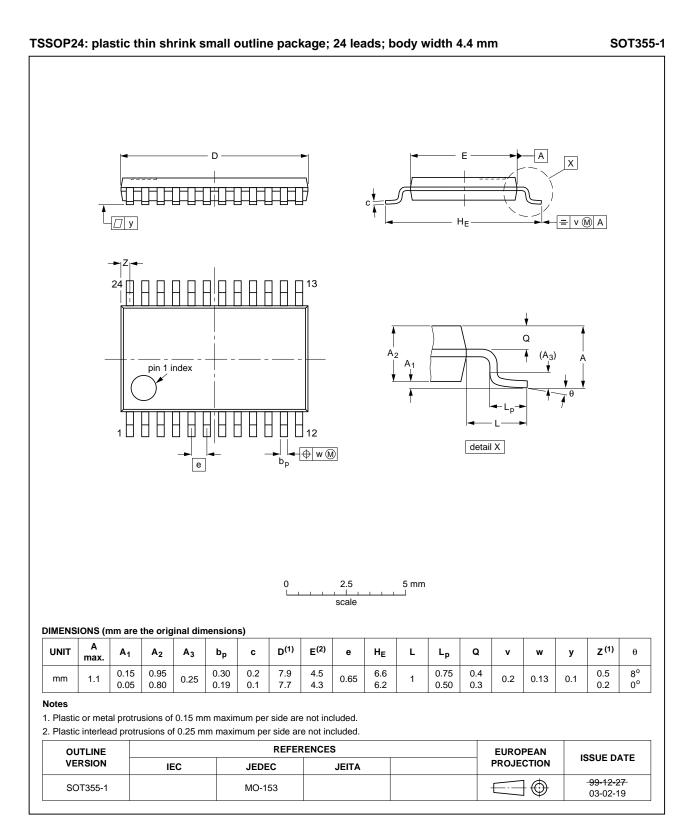
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#### Fig 12. Package outline SOT 340-1 (SSOP24)

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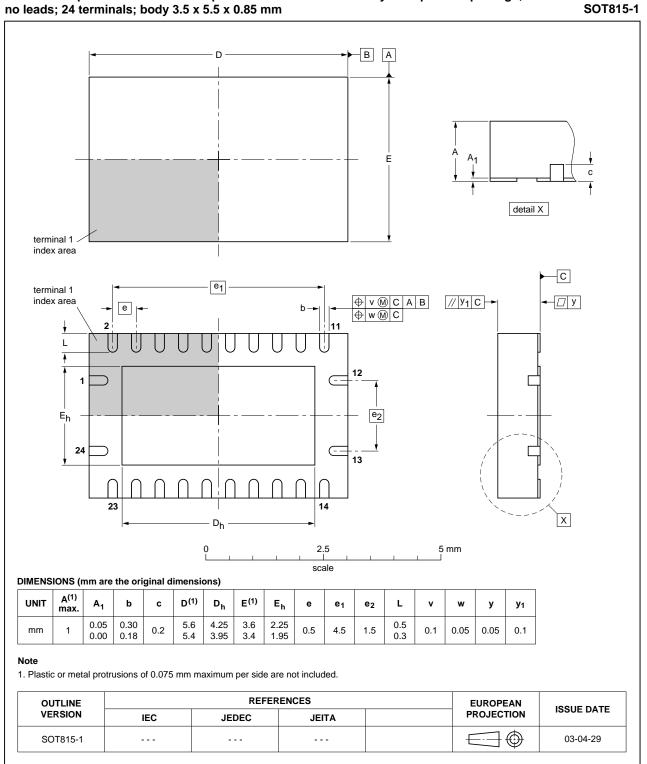
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#### Fig 13. Package outline SOT 355-1 (TSSOP24)

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10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state



#### DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

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Fig 14. Package outline SOT 815-1 (DHVQFN24)

10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

## **13. Abbreviations**

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

Table 11. Revision	history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74LVC821A v.4	20121123	Product data sheet	-	74LVC821A v.3		
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.</li> </ul>					
	<ul> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>					
	• <u>Table 4</u> , <u>Table 5</u> , <u>Table 6</u> , <u>Table 7</u> , and <u>Table 8</u> : values added for lower voltage ranges.					
74LVC821A v.3	20040511	Product specification	-	74LVC821A v.2		
74LVC821A v.2	20040415	Product specification	-	74LVC821A v.1		
74LVC821A v.1	19980925	Product specification	-	-		

## 15. Legal information

#### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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### 10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

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10-bit D-type flip-flop; 5 V tolerance; positive-edge trigger; 3-state

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